400KHz 60V 2A Switching Current Boost DC/DC Converter XL6007

Features

- Wide 3.6V to 24V Input Voltage Range
- Positive or Negative Output Voltage Programming with a Single Feedback Pin
- Current Mode Control Provides Excellent Transient Response
- 1.25V reference adjustable version
- Fixed 400KHz Switching Frequency
- Maximum 2A Switching Current
- SW PIN Built in Over Voltage Protection
- Excellent line and load regulation
- EN PIN TTL shutdown capability
- Internal Optimize Power MOSFET
- High efficiency up to 90%
- Built in Frequency Compensation
- Built in Soft-Start Function
- Built in Thermal Shutdown Function
- Built in Current Limit Function
- Available in SOP8 package

Applications

- Automotive and Industrial Boost / Buck-Boost / Inverting Converters
- Portable Electronic Equipment

General Description

The XL6007 regulator is a wide input range, current mode, DC/DC converter which is capable of generating either positive or negative output voltages. It can be configured as either a boost, flyback, SEPIC or inverting converter. The XL6007 built in N-channel power MOSFET and fixed frequency oscillator, current-mode architecture results in stable operation over a wide range of supply and output voltages.

The XL6007 regulator is special design for portable electronic equipment.

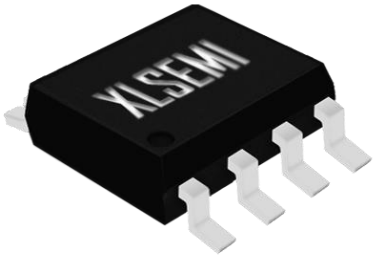


Figure1. Package Type of XL6007

Pin Configurations

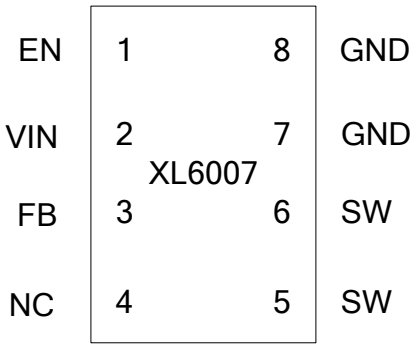


Figure2. Pin Configuration of XL6007 (Top View)

Table 1 Pin Description

Pin Number	Pin Name	Description
1	EN	Enable Pin. Drive EN pin low to turn off the device, drive it high to turn it on. Floating is default high.
2	VIN	Supply Voltage Input Pin. XL6007 operates from a 3.6V to 24V DC voltage. Bypass Vin to GND with a suitably large capacitor to eliminate noise on the input.
3	FB	Feedback Pin (FB). The feedback threshold voltage is 1.25V.
4	NC	No Connected.
5,6	SW	Power Switch Output Pin (SW). Output is the switch node that supplies power to the output.
7,8	GND	Ground Pin.

Function Block

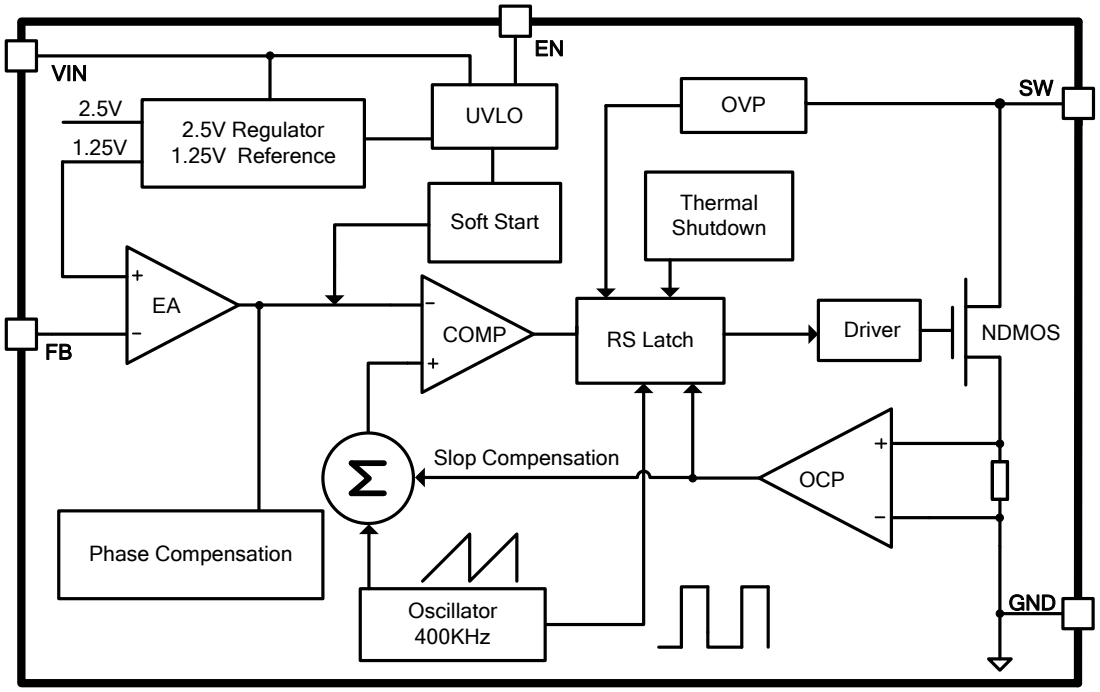


Figure3. Function Block Diagram of XL6007

Typical Application Circuit

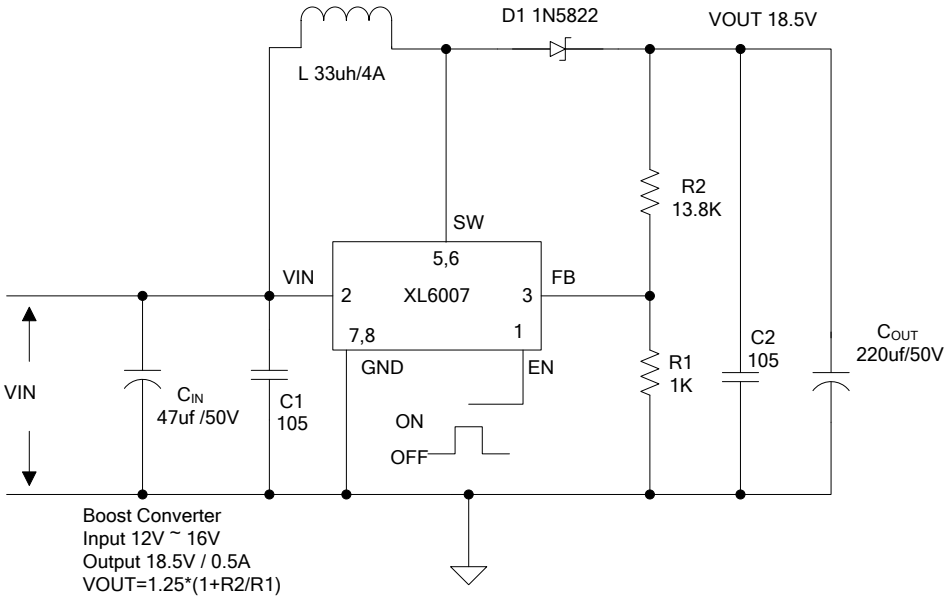


Figure4. XL6007 Typical Application Circuit (Boost Converter)

Ordering Information

Order Information	Marking ID	Package Type	Packing Type Supplied As
XL6007E1	XL6007E1	SOP8	2500/4000 Units on Tape & Reel

XLSEMI Pb-free products, as designated with "E1" suffix in the par number, are RoHS compliant.

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit
Input Voltage	Vin	-0.3 to 26	V
Feedback Pin Voltage	V_{FB}	-0.3 to Vin	V
EN Pin Voltage	V_{EN}	-0.3 to Vin	V
Output Switch Pin Voltage	V_{SW}	-0.3 to 60	V
Power Dissipation	P_D	Internally limited	mW
Thermal Resistance (SOP8) (Junction to Ambient, No Heatsink, Free Air)	R_{JA}	100	°C/W
Operating Junction Temperature	T_J	-40 to 125	°C
Storage Temperature	T_{STG}	-65 to 150	°C
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	260	°C
ESD (HBM)		>2000	V

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

XL6007 Electrical Characteristics

T_a = 25℃;unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
System parameters test circuit figure4						
VFB	Feedback Voltage	Vin = 12V to 16V, Vout=18V Iload=0.1A to 0.5A	1.213	1.25	1.287	V
η	Efficiency	Vin=12V ,Vout=18.5V Iout=0.5A	–	90	–	%

Electrical Characteristics (DC Parameters)

Vin = 12V, GND=0V, Vin & GND parallel connect a 220uf/50V capacitor; Iout=0.5A, T_a = 25℃; the others floating unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input operation voltage	Vin		3.6		24	V
Shutdown Supply Current	I_S	V_{EN}=0V		70	100	uA
Quiescent Supply Current	I_q	V_{EN} =2V, V_{FB} =Vin		2.5	5	mA
Oscillator Frequency	Fosc		320	400	480	Khz
Switch Current Limit	I_L	V_{FB} =0V		2		A
Output Power NMOS	Rdson	Vin=12V, I_{SW}=2A		110	120	mohm
EN Pin Threshold	V_{EN}	High (Regulator ON) Low (Regulator OFF)		1.4 0.8		V
EN Pin Input Leakage Current	I_H	V_{EN} =2V (ON)		3	10	uA
	I_L	V_{EN} =0V (OFF)		3	10	uA
Max. Duty Cycle	D_{MAX}	V_{FB}=0V		90		%

Schottky Diode Selection Table

Current	Surface Mount	Through Hole	VR (The same as system maximum input voltage)				
			20V	30V	40V	50V	60V
1A		✓	1N5817	1N5818	1N5819		
3A		✓	1N5820	1N5821	1N5822		
		✓	MBR320	MBR330	MBR340	MBR350	MBR360
	✓		SK32	SK33	SK34	SK35	SK36
	✓			30WQ03	30WQ04	30WQ05	
		✓		31DQ03	31DQ04	31DQ05	
		✓	SR302	SR303	SR304	SR305	SR306

Typical System Application – Boost (Output 18.5V/0.5A)

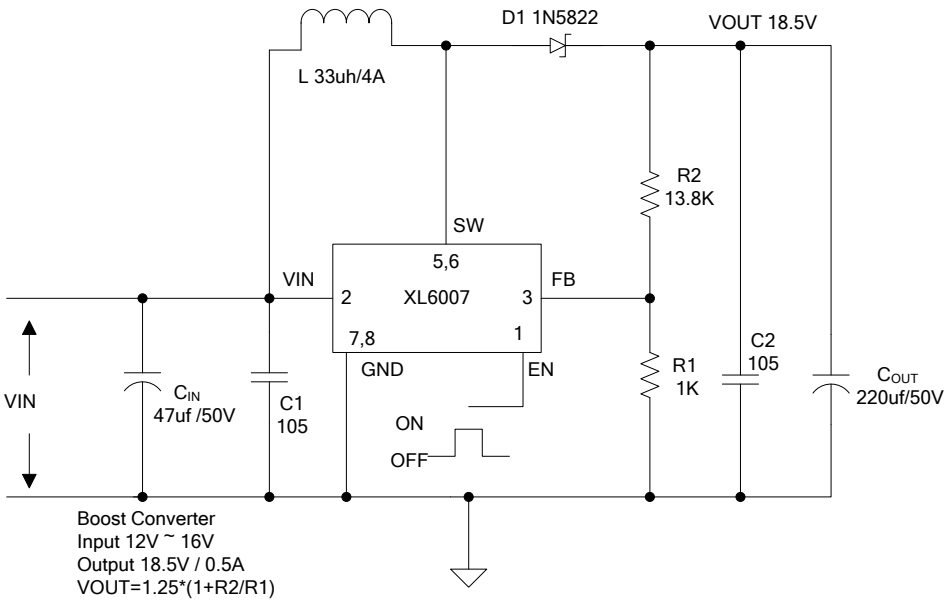


Figure5. XL6007 Typical System Application (Boost Converter)

Typical System Application – SEPIC Buck-Boost (Input 10V~18V, Output 12V/0.5A)

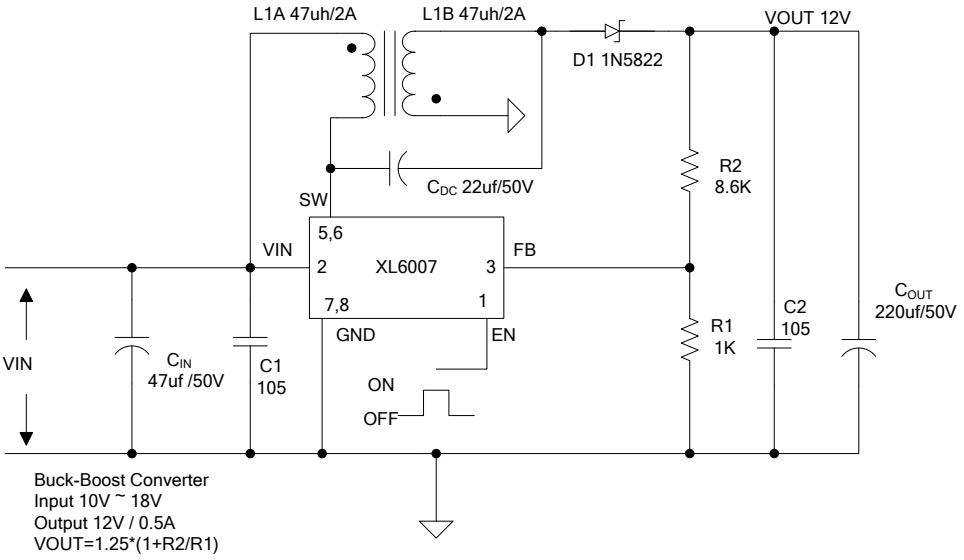


Figure6. XL6007 Typical System Application (SEPIC Buck-Boost Converter)

Typical System Application for Inverting Converter–SEPIC Inverting Topology (Input 10V~18V, Output + -12V/0.6A)

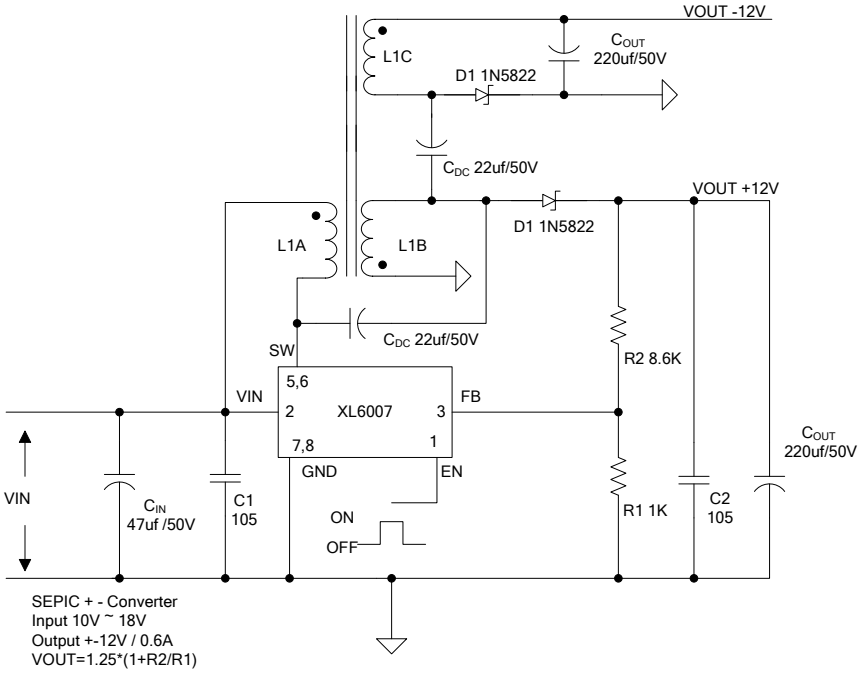
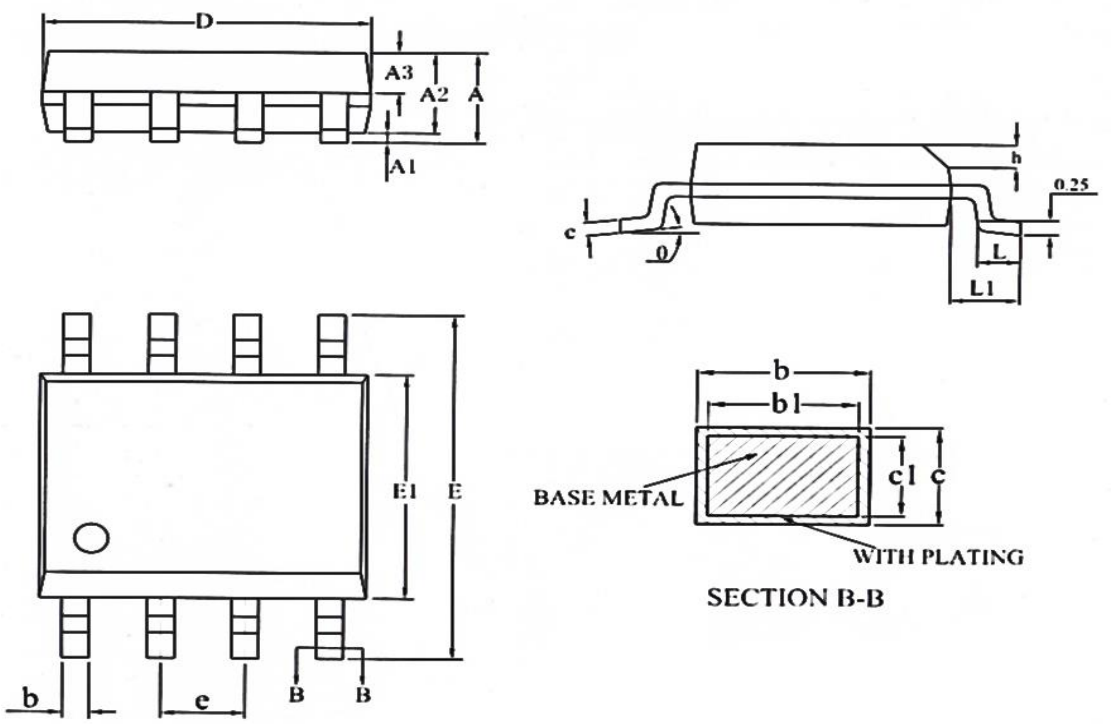


Figure7. XL6007 Typical System Application (SEPIC Inverting Converter)

Package Information

SOP8



Symbol	Dimensions In Millimeters			Dimensions In Millimeters		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.35	1.55	1.75	0.053	0.061	0.069
A1	0.05	–	0.25	0.002	–	0.010
A2	1.25	1.40	1.65	0.049	0.055	0.065
A3	0.50	0.60	0.70	0.019	0.024	0.028
b	0.30	–	0.51	0.012	–	0.020
b1	0.29	0.41	0.48	0.011	0.016	0.018
c	0.17	–	0.25	0.007	–	0.010
c1	0.17	0.20	0.23	0.007	0.008	0.009
D	4.70	4.90	5.10	0.185	0.193	0.200
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	1.14	1.27	1.40	0.045	0.050	0.055
h	0.25	–	0.50	0.010	–	0.020
L	0.45	–	0.80	0.017	–	0.031
L1	0.82	1.03	1.23	0.032	0.040	0.048
θ	0	–	8°	0	–	8°

Important Notice

XLSEMI reserve the right to make modifications, enhancements, improvements, corrections or other changes without notice at any time. XLSEMI does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. XLSEMI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using XLSEMI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards. XLSEMI warrants performance of its products to the specifications applicable at the time of sale, in accordance with the warranty in XLSEMI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent XLSEMI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

For the latest product information, go to www.xlsemi.com.